

2016 Medical Electronics Conference: September 14																																																	
7:30am - 8:25am	Registration / Networking / Breakfast - (Hawthorne Room)																																																
8:25am - 9:10am	The President's Precision Medicine Initiative: The Opportunities and Challenges of Analytics on Integrated Data from One Million Patients Keynote: Bob Rogers, Intel (Hawthorne Room)																																																
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8:00am - 8:45am	Functional Electronic Clones & China's plan to Dominate the Semiconductor-Manufacturing Industry Tom Sharpe, SMT Corporation																						
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